

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	41	(US-20020025689-\$ or US-20020105080-\$ or US-20020177080-\$ or US-20030042611-\$ or US-20030052411-\$ or US-20030057476-\$ or US-20030075801-\$ or US-20030116852-\$ or US-20030146504-\$ or US-20050032275-\$).did. or (US-5053992-\$ or US-5157725-\$ or US-5535526-\$ or US-5652465-\$ or US-5669783-\$ or US-5747830-\$ or US-5761361-\$ or US-5815226-\$ or US-5955380-\$ or US-5998814-\$ or US-6080646-\$ or US-6154132-\$ or US-6294816-\$ or US-6329594-\$ or US-6384464-\$ or US-6433438-\$ or US-6455894-\$ or US-6486039-\$ or US-6664642-\$ or US-6670684-\$ or US-6683351-\$ or US-6740942-\$ or US-6747310-\$ or US-6815816-\$).did. or (JP-01057645-\$ or JP-05029312-\$ or JP-05206298-\$ or JP-08186068-\$ or JP-2000307000-\$ or JP-62193265-\$).did. or (JP-05206298-\$).did.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/10/28 13:53
L2	1	tensile with dummy with interconnect	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L3	3	tensile with dummy with interconnect\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L4	3	tensile same dummy with interconnect\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L5	7	tensile same dummy same interconnect\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06

L6	11	tensile same dummy with via	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L7	250	tensile same dummy	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L8	21	tensile same dummy and "257"/\$. ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L9	16	stress with dummy with interconnect\$4 and "257"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L10	1	L9 not "16"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L11	14	L9 not L8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L12	81	tensile with dummy	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L13	2	jp-07106323-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L14	1	1995-188909.NRAN.	DERWENT	OR	ON	2005/10/28 15:06
L15	1	1993jp-0249642.ap,prai.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06

L16	1	interconnect\$3 with stress with relive	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L17	236	interconnect\$3 with stress with relief	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L18	82	L17 and "257"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L19	53	via with (stress strain) with relief and "257"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L20	47	L19 not L18	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L21	18	(on near2 functional dummy sacrificial)near2 via with (stress strain) and "257"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L22	22	silicon adj nitride with stress with via	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L23	7	(on near2 functional dummy sacrificial)near2 via with (silicon near2 nitride) and "257"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L24	7	(no near2 functional dummy sacrificial)near2 via with (silicon near2 nitride) and "257"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06

L25	7	L23 and L24	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L26	2	"5793113".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L27	133683	ceramic with glass	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L28	9910	ceramic with glass and "257"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L29	1110	(257/417).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/28 15:06
L30	31	L29 and ceramic with glass	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L31	78	interconnection with stress with tensile	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L32	48	interconnection and stress and tensile	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L33	0	interconnection same stress same tensile and 257/773.ccls.	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L34	5	interconnection same stress same tensile and 257/773.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06

L35	5	interconnection same stress same tensile and 257/774.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L36	4	L34 and L35	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L37	187	((on no non) near2 functional dummy sacrificial)and 257/773.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L38	10	via with siN with stress	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L39	8	("5767549" "6020616" "6130139" "6281593" "6337230" "6414354").PN. OR ("6455894").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L40	141	andujar.xa.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L41	14	L40 and reverse	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L42	4945	dummy with transistor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L43	1	dummy with transistor with security	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06

L44	165	<i>dummy with transistor with prevent</i>	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L45	244	<i>dummy with transistor with prevent\$3</i>	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L46	102	<i>transistor with prevent\$3 near read\$3</i>	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L47	1396610	<i>transistor with prevent\$3 near external detection</i>	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L48	0	<i>transistor with prevent\$3 near external near3 detection</i>	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L49	0	<i>memory with cell with prevent\$3 near external near3 detection</i>	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L50	25	<i>prevent\$3 near external near3 detection</i>	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L51	67	<i>phantom with signal and "257"/\$. ccls.</i>	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L52	189	<i>phantom adj signal</i>	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06

L53	94	transistor with diode with security	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L54	0	transistor with hidding with pattern with diode	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L55	0	transistor with hid\$5 with pattern with diode	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L56	28	transistor with hid\$5 with diode	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06

L57	107	("3673471" "3946426" "4017888" "4101344" "4139864" "4164461" "4196443" "4267578" "4291391" "4295897" "4314268" "4317273" "4322736" "4374454" "4409434" "4435895" "4471376" "4581628" "4583011" "4603381" "4623255" "4727493" "4766516" "4799096" "4821085" "4830974" "4939567" "4962484" "4975756" "4998151" "5030796" "5050123" "5061978" "5065208" "5068697" "5070378" "5101121" "5117276" "5121089" "5121186" "5132571" "5138197" "5146117" "5168340" "5177589" "5202591" "5225699" "5227649" "5231299" "5302539" "5308682" "5309015" "5317197" "5336624" "5341013" "5345105" "5354704" "5369299" "5371390" "5376577" "5384472" "5384475" "5399441" "5404040" "5412237" "5441902" "5468990" "5475251" "5506806" "5531018" "5539224" "5541614" "5571735" "5576988" "5611940" "5638946" "5677557" "5679595" "5719422" "5719430" "5721150" "5783846" "5821590" "5838047" "5854510" "5866933" "5880503" "5888887" "5895241" "5920097" "5930663" "5930667" "5973375" "5977593" "5998257" "6037627" "6046659" "6054659" "6057520" "6080614" "6117762" "6137318" "6154388" "6215158" "6294816" "6326675" "6503787").PN. OR ("6815816").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L58	62	("3946426" "4139864" "4164461" "4267578" "4291391" "4295897" "4314268" "4317273" "4374454" "4435895" "4471376" "4581628" "4583011" "4603381" "4623255" "4727493" "4766516" "4799096" "4821085" "4830974" "4975756" "5030796" "5050123" "5061978" "5065208" "5068697" "5070378" "5101121" "5117276" "5132571" "5138197" "5146117" "5168340" "5202591" "5227649" "5231299" "5302539" "5308682" "5309015" "5336624" "5341013" "5354704" "5369299" "5371390" "5376577" "5384472" "5399441" "5441902" "5468990" "5475251" "5539224" "5721150" "5866933").PN. OR ("6294816").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L59	1551	reverse and engineering and "257"/\$.ccls.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06

L60	128	reverse near2 engineering and "257"/\$.ccls.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L61	108	("3673471" "3946426" "4017888" "4101344" "4139864" "4164461" "4196443" "4267578" "4291391" "4295897" "4314268" "4317273" "4322736" "4374454" "4409434" "4435895" "4471376" "4581628" "4583011" "4603381" "4623255" "4727493" "4766516" "4799096" "4821085" "4830974" "4939567" "4962484" "4975756" "4998151" "5030796" "5050123" "5061978" "5065208" "5068697" "5070378" "5101121" "5117276" "5121089" "5121186" "5132571" "5138197" "5146117" "5168340" "5202591" "5225699" "5227649" "5231299" "5302539" "5308682" "5309015" "5317197" "5336624" "5341013" "5345105" "5354704" "5369299" "5371390" "5376577" "5384472" "5384475" "5399441" "5404040" "5412237" "5441902" "5468990" "5475251" "5506806" "5531018" "5539224" "5541614" "5571735" "5576988" "5611940" "5638946" "5677557" "5679595" "5719422" "5719430" "5721150" "5783846" "5821590" "5838047" "5854510" "5866933" "5880503" "5888887" "5895241" "5920097" "5930663" "5930667" "5973375" "5977593" "6037627" "6046659" "6054659" "6057520" "6080614" "6117762" "6137318" "6154388" "6215158" "6294816" "6326675" "6503787").PN. OR ("6740942"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L62	8	("4105216" "5384457" "5940545" "6028952").PN. OR ("6515304"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L63	0	L60 and transisor with diode	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L64	20	L60 and transistor with diode	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L65	14	("4665503" "4758984" "4933898").PN. OR ("5053992"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L66	7	("20020117682" "20030016084" "5053992" "5235197" "5461425" "5900623" "6355965").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06

L67	19	(US-20020105080-\$ or US-20030116852-\$).did. or (US-5053992-\$ or US-5157725-\$ or US-5761361-\$ or US-5955380-\$ or US-6154132-\$ or US-6294816-\$ or US-6455894-\$ or US-6486039-\$ or US-6740942-\$ or US-6815816-\$). did. or (JP-01057645-\$ or JP-05029312-\$ or JP-05206298-\$ or JP-08186068-\$ or JP-2000307000-\$ or JP-62193265-\$).did. or (JP-05206298-\$).did.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/10/28 15:06
L68	15	dummy with interconnection with void	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/10/28 15:06
L69	0	dummy with interconnection with prevent with tensile	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/10/28 15:06
L70	1	dummy with interconnection with tensile	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/10/28 15:06
L71	56	dummy with interconnection with prevent	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/10/28 15:06
L72	22	("20010010093" "20020109190" "5235201" "5410161" "5550701" "5760445" "5903031" "5977594" "6013927" "6034433" "6292927" "6294397" "6320234" "6344385" "6372525" "6417544" "6448599" "6465768" "6465848" "6469325" "6504229" "6600176").PN. OR ("6683351").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L73	4	dummy near2 interconnection with sidewall	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L74	4	dummy near2 interconnection with sidewall	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L75	1	dummy near2 interconnection and sidewall	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L76	6	dummy and interconnection and sidewall	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06

L77	8	("5767549" "6020616" "6130139" "6281593" "6337230" "6414354").PN. OR ("6455894").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L78	129	siN with tensile with stress	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L79	0	spacer with silicon with nitride with preferred	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L80	9822	spacer with silicon with nitride	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L81	0	spacer with silicon with nitride with preferred	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L82	0	spacer with silicon with nitride with prefer\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L83	0	spacer with silicon with nitride with preffer\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L84	121	spacer with silicon with nitride with stress	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L85	383	spacer with silicon with nitride with insulation	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06

L86	6	spacer with silicon with nitride with insulation with (good excellent)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L87	65	spacer with silicon with nitride with prefer\$5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L88	1213	(228/180.22).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/28 15:06
L89	144	L88 and flexible with substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L90	7	("5031308" "5147210").PN. OR ("5346117").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L91	1000	(228/180.5).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/28 15:06
L92	0	("6andcable").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/28 15:06
L93	49	L91 and cable	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L94	887	257/730.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L95	102	L94 and flexible	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06

L96	778	257/776.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L97	61	L96 and flexible	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L98	24	("4999656" "5219292" "5315484" "5666573").PN. OR ("5764497"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L99	10	("4254445" "4371744" "4489364" "5018005" "5396032" "5426263" "5452182" "5533256" "5764497" "5936850").PN. OR ("6329594"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L100	0	"5706174.pn.."	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L101	2	"5706174".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L102	58	("4234666" "4642889" "5127570" "5148265" "5148266" "5194930" "5203076" "5249101" "5316788" "5355283" "5398863" "5477611" "5518964" "5563445").PN. OR ("5706174").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L103	58	("4234666" "4642889" "5127570" "5148265" "5148266" "5194930" "5203076" "5249101" "5316788" "5355283" "5398863" "5477611" "5518964" "5563445").PN. OR ("5706174").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L104	27	"5479319"	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L105	0	"479319".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L106	1	"5479319".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L107	556	bump with pin with package	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06

L108	25	("3340496" "3880486" "4453060" "4560216" "4696104" "4854882" "4950170" "5127837" "5205742" "5241453" "5322446" "5340947" "5386626" "5485351").PN. OR ("5669783").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L109	25	("3340496" "3880486" "4453060" "4560216" "4696104" "4854882" "4950170" "5127837" "5205742" "5241453" "5322446" "5340947" "5386626" "5485351").PN. OR ("5669783").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L110	12191	(semiconductor chip IC integrated adj circuit die wafer) with (wiring bonding wire) with (c4 solder adj ball bump)	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L111	1381	L110 and pin with (c4 solder adj ball bump)	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L112	845	L110 and pin with (connect\$3 contact\$3 coupl\$3 interconnect\$3) with (c4 solder adj ball bump)	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L113	531	L110 and pin with (connect\$3 contact\$3 coupl\$3 interconnect\$3) with (c4 solder adj ball bump)	USPAT	OR	ON	2005/10/28 15:06
L114	1	"6103626".pn.	USPAT	OR	ON	2005/10/28 15:06
L115	15	("5220199" "5289422" "5357140" "5430325" "5459093" "5529954" "5556805" "5652465").PN. OR ("6103626").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L116	15	("5293503" "5430325").PN. OR ("5652465").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L117	1	"6259407".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L118	2210	dummy with pattern and via	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L119	361	dummy with pattern with via	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L120	5	dummy with pattern with tensile	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06

L121	52	dummy with pattern with stress and "257"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L122	2	("4746966" "5534726").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L123	1780	dummy with pattern and "257"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L124	86	interconnect\$2 with dummy with pattern and "257"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L125	418	dummy with pattern and "257"/7\$2.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L126	358	L125 not (L121 L124)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L127	2	"20040251555".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L128	2	"5998814".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L129	2	"6414393".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L130	35	SOG with tensile with stress	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06

L131	36	SiN with silicon near2 oxynitride with CVD	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L132	2	"5754088".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L133	5	("5321380").PN. OR ("5754088"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/28 15:06
L134	7	dummy with (contact plug) with SiN	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L135	47	dummy with (contact plug) with (silicon adj nitride)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L136	4	sealant with break with pattern	US-PGPUB	OR	ON	2005/10/28 15:06
L137	25	tensile with (contact plug) with (silicon adj nitride SiN)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L138	25	tensile with (contact plug) with (silicon adj nitride SiN "Si.sub.3 N. sub.4")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L139	1	interconnection with tensile with dummy	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L140	3	interconnection same dummy same tensile	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06

L141	14	wiring same dummy same tensile	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L142	352	wiring same (plug via contact) same tensile	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06
L143	46	dummy same (plug via contact) same tensile	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/28 15:06